

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

SLVS428A – MAY 2002 – REVISED APRIL 2003

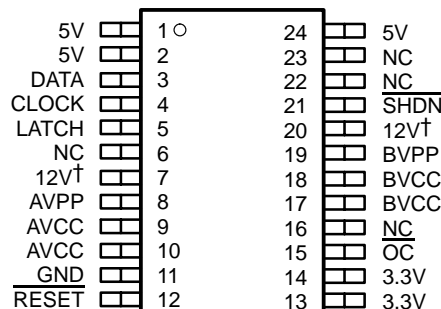
## FEATURES

- Single-Slot Switch: TPS2220A  
Dual-Slot Switches: TPS2223A, TPS2224A, TPS2226A
- Fast Current Limit Response Time
- Fully Integrated VCC and VPP Switching for 3.3 V, 5 V, and 12 V (no 12 V on TPS2223A)
- Meets Current PC Card™ Standards
- V<sub>pp</sub> Output Selection Independent of V<sub>CC</sub>
- 12-V and 5-V Supplies Can Be Disabled
- TTL-Logic Compatible Inputs
- Short-Circuit and Thermal Protection
- 24-Pin HTSSOP, 24- or 30-Pin SSOP
- 140-μA (Typical) Quiescent Current from 3.3-V Input
- Break-Before-Make Switching
- Power-On Reset
- –40°C to 85°C Operating Ambient Temperature Range

## APPLICATIONS

- Notebook and Desktop Computers
- Bar Code Scanners
- Digital Cameras
- Set-Top Boxes
- PDAs

TPS2223A, TPS2224A  
DB OR PWP PACKAGE  
(TOP VIEW)



NC – No internal connection

† Pin 7 and 20 are NC for TPS2223A.

## DESCRIPTION

The TPS2223A, TPS2224A, and TPS2226A CardBus™ power-interface switches provide an integrated power-management solution for two PC Card sockets. The TPS2220A is a single-slot option for this family of devices. These devices allow the controlled distribution of 3.3 V, 5 V, and 12 V to each card slot. The current-limiting and thermal-protection features eliminate the need for fuses. Current-limit reporting helps the user isolate a system fault. The switch  $r_{DS(on)}$  and current-limit values have been set for the peak and average current requirements stated in the PC Card specification, and optimized for cost. A faster maximum current limit response time is the only difference between the TPS2223A, TPS2224A, and TPS2226A and the TPS2223, TPS2224, and TPS2226.

Like the TPS2214 and TPS2214A and the TPS2216 and TPS2216A, this family of devices supports independent VPP/VCC switching; however, the standby and interface-mode pins are not supported. Shutdown mode is now supported independently on  $\overline{SHDN}$  as well as in the serial interface. Optimized for lower power implementation, the TPS2223A does not support 12-V switching to VPP. See the available options table for pin-compatible device information.

## AVAILABLE OPTIONS

T <sub>A</sub>	PACKAGED DEVICES					
	PLASTIC SMALL OUTLINE				PowerPAD™ PLASTIC SMALL OUTLINE (PWP-24)†	
	DB-24			DB-30		
–40°C to 85°C	TPS2223ADB, TPS2224ADB		TPS2220ADB	TPS2226ADB		TPS2223APWP, TPS2224APWP
	Pin compatibles	TPS2214, TPS2214A		Pin compatibles	TPS2216, TPS2216A, TPS2206	

† The DB and PWP packages are also available taped and reeled. Add R suffix to device type (e.g., TPS2223APWPR) for taped and reeled.



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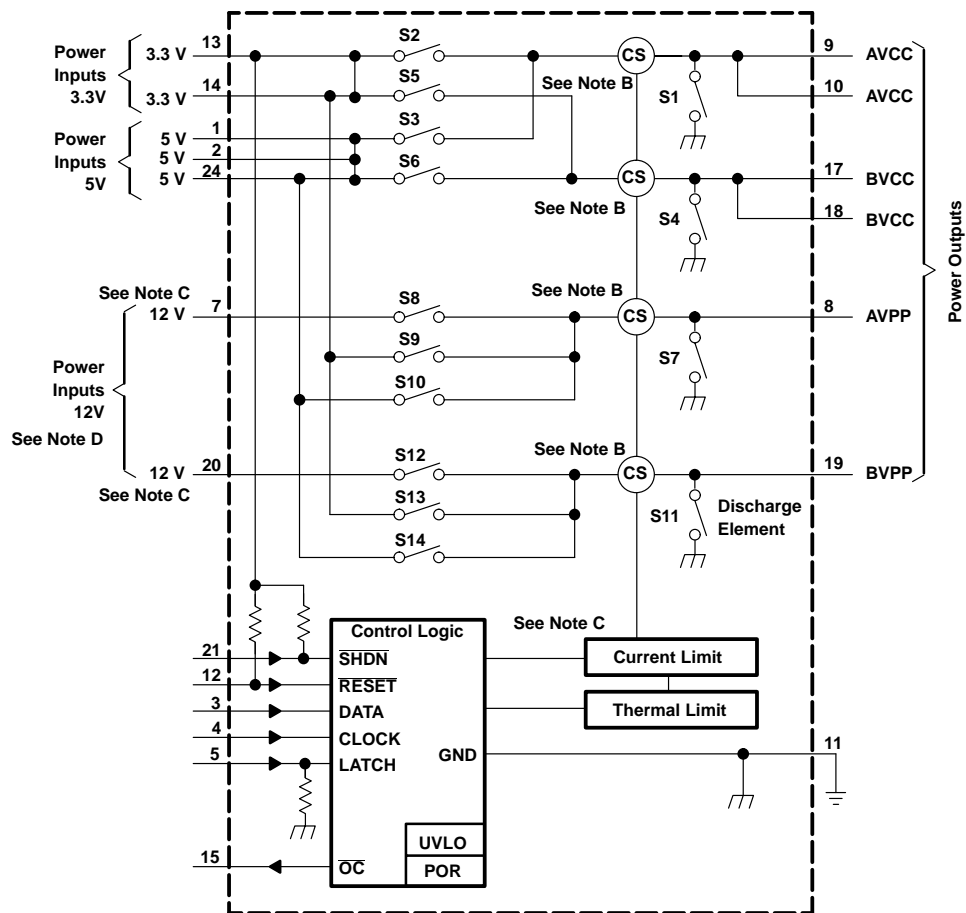
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## functional block diagram of TPS2223A, TPS2224A TPS2226A (See Note A)

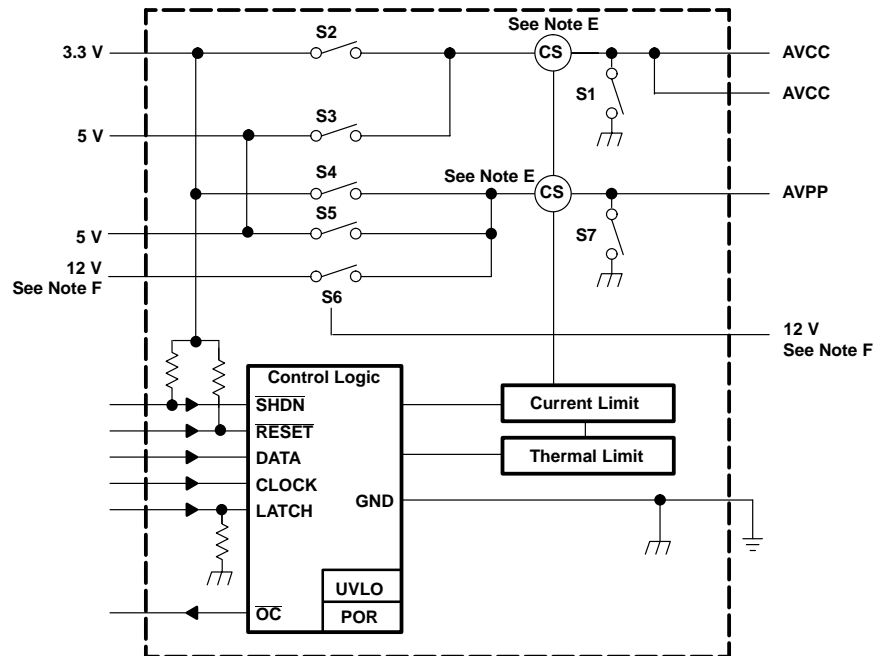


- NOTES: A. Diagram shown for 24-pin DB package.  
 B. Current sense  
 C. The two 12-V pins must be externally connected.  
 D. No connections for TPS2223A.

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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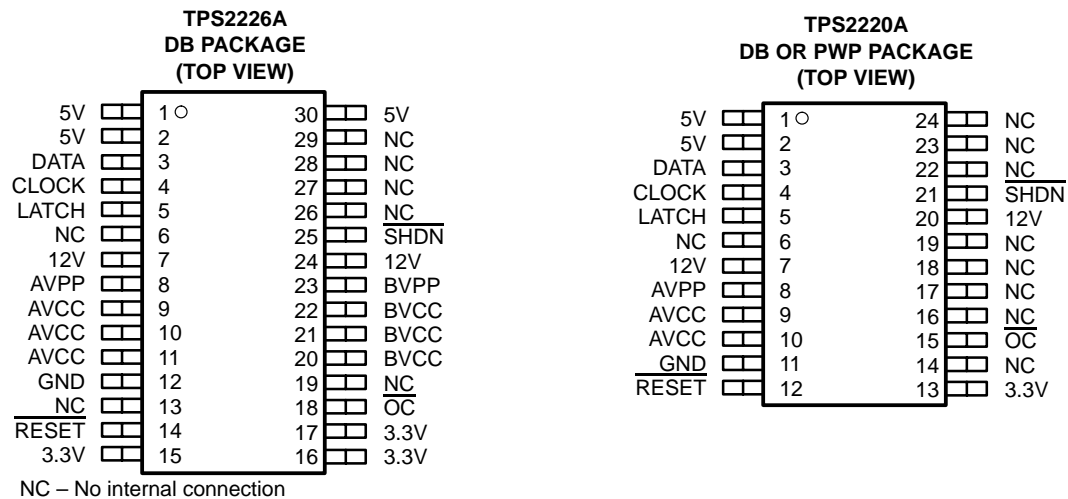
## functional block diagram of TPS2220A



NOTES: E. Current sense

F. The two 12-V pins must be externally connected.

## pin assignments



# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## Terminal Functions

TERMINAL					I/O	DESCRIPTION
NAME	NO.					
	TPS2220A	TPS2223A	TPS2224A	TPS2226A		
3.3V	13	13, 14	13, 14	15, 16, 17	I	3.3-V input for card power and chip power
5V	1, 2	1, 2, 24	1, 2, 24	1, 2, 30	I	5-V input for card power
12V	7, 20	NA	7, 20	7, 24	I	12-V input for card power (xVPP). The two 12-V pins must be externally connected.
AVCC	9, 10	9, 10	9, 10	9, 10, 11	O	Switched output that delivers 3.3 V, 5 V, ground or high impedance to card
AVPP	8	8	8	8	O	Switched output that delivers 3.3 V, 5 V, 12 V, ground or high impedance to card (12 V not applicable to TPS2223A)
BVCC	—	17, 18	17, 18	20, 21, 22	O	Switched output that delivers 3.3 V, 5 V, ground or high impedance to card
BVPP	—	19	19	23	O	Switched output that delivers 3.3 V, 5 V, 12 V, ground or high impedance to card (12 V not applicable for TPS2223A)
GND	11	11	11	12		Ground
$\overline{\text{OC}}$	15	15	15	18	O	Open-drain overcurrent reporting output that goes low when an overcurrent condition exists. An external pullup is required.
$\overline{\text{SHDN}}$	21	21	21	25	I	Hi-Z (open) all switches. Identical function to serial D8. Asynchronous active-low command, internal pullup
$\overline{\text{RESET}}$	12	12	12	14	I	Logic-level RESET input active low. Asynchronous active-low command, internal pullup
CLOCK	4	4	4	4	I	Logic-level clock for serial data word
DATA	3	3	3	3	I	Logic-level serial data word
LATCH	5	5	5	5	I	Logic-level latch for serial data word, internal pulldown
NC	6, 14, 16, 17, 18, 19, 22, 23, 24	6, 7, 16, 20, 22, 23	6, 16, 22, 23	6, 13, 19, 26, 27, 28, 29		No internal connection

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## absolute maximum ratings over operating free-air temperature (unless otherwise noted)<sup>†</sup>

Input voltage range for card power: $V_{I(3.3V)}$	–0.3 V to 5.5 V
$V_{I(5V)}$	–0.3 V to 5.5 V
$V_{I(12V)}^{\ddagger}$	–0.3 V to 14 V
Logic input/output voltage	–0.3 V to 6 V
Output voltage: $V_{O(xVCC)}$	–0.3 V to 6 V
$V_{O(xVPP)}$	–0.3 V to 14 V
Continuous total power dissipation	See Dissipation Rating Table
Output current: $I_{O(xVCC)}$	Internally Limited
$I_{O(xVPP)}$	Internally Limited
Operating virtual junction temperature range, $T_J$	–40°C to 100°C
Storage temperature range, $T_{STG}$	–55°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds)	260°C
$\overline{OC}$ sink current	10 mA

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

<sup>‡</sup> Not applicable for TPS2223A

DISSIPATION RATING TABLE

PACKAGE§		$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
DB	24	890 mW	8.9 mW/°C	489 mW	356 mW
	30	1095 mW	10.95 mW/°C	602 mW	438 mW
PWP	24	3322 mW	33.22 mW/°C	1827 mW	1329 mW

§ These devices are mounted on an JEDEC low-k board (2-oz. traces on surface).

## recommended operating conditions

		MIN	MAX	UNIT
Input voltage, $V_{I(3.3V)}$ is required for all circuit operations. 5V and 12V are only required for their respective functions.	$V_{I(3.3V)}^{\parallel}$	3	3.6	V
	$V_{I(5V)}$	3	5.5	
	$V_{I(12V)}^{\ddagger}$	7	13.5	
Output current, $I_O$	$I_{O(xVCC)}$ at $T_J = 100^\circ\text{C}$		1	A
	$I_{O(xVPP)}$ at $T_J = 100^\circ\text{C}$		100	mA
Clock frequency, $f_{\text{clock}}$			2.5	MHz
Pulse duration, $t_w$	Data		200	ns
	Latch		250	
	Clock		100	
	Reset		100	
Data-to-clock hold time, $t_h$ (see Figure 2)			100	ns
Data-to-clock setup time, $t_{su}$ (see Figure 2)			100	ns
Latch delay time, $t_{d(\text{latch})}$ (see Figure 2)			100	ns
Clock delay time, $t_{d(\text{clock})}$ (see Figure 2)			250	ns
Operating virtual junction temperature, $T_J$ (maximum to be calculated at worst case $P_D$ at 85°C ambient)		–40	100	°C

<sup>‡</sup> Not applicable for TPS2223A

<sup>||</sup> It is understood that for  $V_{I(3.3V)} < 3$  V, voltages within the absolute maximum ratings applied to pin 5V or pin 12V do not damage the IC.



# TPS2220A, TPS2223A, TPS2224A, TPS2226A

## CARDBUS POWER-INTERFACE SWITCHES

### FOR SERIAL PCMCIA CONTROLLERS

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electrical characteristics,  $T_J = 25^\circ\text{C}$ ,  $V_{I(5V)} = 5\text{ V}$ ,  $V_{I(3.3V)} = 3.3\text{ V}$ ,  $V_{I(12V)} = 12\text{ V}$  (not applicable for TPS2223A), all outputs unloaded (unless otherwise noted)

#### power switch

PARAMETER			TEST CONDITIONS†		MIN	TYP	MAX	UNIT
$r_{DS(on)}$	Static drain-source on-state resistance	3.3V to xVCC, (see Note 1)	$I_O = 750\text{ mA}$ each			85	110	$\text{m}\Omega$
			$I_O = 750\text{ mA}$ each, $T_J = 100^\circ\text{C}$			110	140	
		5V to xVCC, (see Note 1)	$I_O = 500\text{ mA}$ each			95	130	$\text{m}\Omega$
			$I_O = 500\text{ mA}$ each, $T_J = 100^\circ\text{C}$			120	160	
		3.3V or 5V to xVPP, (see Note 1)	$I_O = 50\text{ mA}$ each			0.8	1	$\Omega$
			$I_O = 50\text{ mA}$ each, $T_J = 100^\circ\text{C}$			1	1.3	
Output discharge resistance	Discharge at xVCC	$I_{O(disc)} = 1\text{ mA}$			0.5	0.7	1	$\text{k}\Omega$
					0.2	0.4	0.5	
$I_{OS}$	Short-circuit output current	Limit (steady-state value), output powered into a short circuit	$I_{OS(xVCC)}$		1	1.4	2	A
			$I_{OS(xVPP)}$		120	200	300	mA
		Limit (steady-state value), output powered into a short circuit, $T_J = 100^\circ\text{C}$	$I_{OS(xVCC)}$		1	1.4	2	A
			$I_{OS(xVPP)}$		120	200	300	mA
Thermal shutdown temperature (see Note 1)	Thermal trip point, $T_J$	Rising temperature				135		$^\circ\text{C}$
	Hysteresis, $T_J$					10		
Current-limit response time (see Note 2 and Note 3)			5V to xVCC = 5 V, with 100-m $\Omega$ short to GND			10		$\mu\text{s}$
			5V to xVPP = 5 V, with 100-m $\Omega$ short to GND			3		
$I_I$	Normal operation	$I_{I(3.3V)}$	$V_O(xVCC) = V_O(xVPP) = 3.3\text{ V}$ and also for $\text{RESET} = 0\text{ V}$			140	200	$\mu\text{A}$
		$I_{I(5V)}$				8	12	
		$I_{I(12V)}$				100	180	
	Shutdown mode	$I_{I(3.3V)}$	$V_O(xVCC) = V_O(xVPP) = \text{Hi-z}$			0.3	2	
		$I_{I(5V)}$				0.1	2	
		$I_{I(12V)}$				0.3	2	
$I_{lkg}$	Leakage current, output off state	Shutdown mode	$V_O(xVCC) = 5\text{ V}$ , $V_{I(5V)} = V_{I(12V)} = 0\text{ V}$			10		$\mu\text{A}$
			$T_J = 100^\circ\text{C}$			50		
		Shutdown mode	$V_O(xVPP) = 12\text{ V}$ , $V_{I(5V)} = V_{I(12V)} = 0\text{ V}$			10		
			$T_J = 100^\circ\text{C}$			50		

† Pulse-testing techniques maintain junction temperature close to ambient temperature; thermal effects must be taken into account separately.

NOTES: 1. TPS2223A, TPS2224A, TPS2226A: two switches on. TPS2220A: one switch on.

2. Specified by design; not tested in production.

3. From application of short to 110% of final current limit.



**TPS2220A, TPS2223A, TPS2224A, TPS2226A**  
**CARDBUS POWER-INTERFACE SWITCHES**  
**FOR SERIAL PCMCIA CONTROLLERS**

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electrical characteristics,  $T_J = 25^\circ\text{C}$ ,  $V_{I(5V)} = 5\text{ V}$ ,  $V_{I(3.3V)} = 3.3\text{ V}$ ,  $V_{I(12V)} = 12\text{ V}$  (not applicable for TPS2223A), all outputs unloaded (unless otherwise noted) (continued)

logic section (CLOCK, DATA, LATCH,  $\overline{\text{RESET}}$ ,  $\overline{\text{SHDN}}$ ,  $\overline{\text{OC}}$ )

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$I_I$	Input current, logic	$\overline{\text{RESET}} = 5.5\text{ V}$	-1		1	$\mu\text{A}$
		$\overline{\text{RESET}} = 0\text{ V}$	-30	-20	-10	
	$I_I(\overline{\text{SHDN}})$ (see Note 3)	$\overline{\text{SHDN}} = 5.5\text{ V}$	-1		1	
		$\overline{\text{SHDN}} = 0\text{ V}$	-50		-3	
	$I_I(\text{LATCH})$ (see Note 3)	LATCH = 5.5 V			50	
		LATCH = 0 V	-1		1	
	$I_I(\text{CLOCK, DATA})$	0 V to 5.5 V	-1		1	
$V_{IH}$	High-level input voltage, logic		2			V
$V_{IL}$	Low-level input voltage, logic				0.8	V
$V_{O(\text{sat})}$	Output saturation voltage at $\overline{\text{OC}}$	$I_O = 2\text{ mA}$		0.14	0.4	V
$I_{lkg}$	Leakage current at $\overline{\text{OC}}$	$V_{O(\overline{\text{OC}})} = 5.5\text{ V}$		0	1	$\mu\text{A}$

NOTE 3: LATCH has low-current pulldown.  $\overline{\text{RESET}}$  and  $\overline{\text{SHDN}}$  have low-current pullup.

UVLO and POR (power-on reset)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$V_{I(3.3V)}$	Input voltage at 3.3V pin, UVLO	3.3-V level below which all switches are Hi-Z	2.4	2.7	2.9	V
$V_{hys(3.3V)}$	UVLO hysteresis voltage at VA (see Note 1)			100		mV
$V_{I(5V)}$	Input voltage at 5V pin, UVLO	5-V level below which only 5V switches are Hi-Z	2.3	2.5	2.9	V
$V_{hys(5V)}$	UVLO hysteresis voltage at 5V (see Note 1)			100		mV
$t_{df}$	Delay time for falling response, UVLO (see Note 1)	Delay from voltage hit (step from 3 V to 2.3 V) to Hi-Z control (90% $V_G$ to GND)		4		$\mu\text{s}$
$V_{I(\text{POR})}$	Input voltage, power-on reset (see Note 1)	3.3-V voltage below which POR is asserted causing a RESET internally with all line switches open and all discharge switches closed.			1.7	V

NOTE 1: Specified by design; not tested in production.

# TPS2220A, TPS2223A, TPS2224A, TPS2226A

## CARDBUS POWER-INTERFACE SWITCHES

### FOR SERIAL PCMCIA CONTROLLERS

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switching characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ ,  $V_{I(3.3V)} = 3.3\text{ V}$ ,  $V_{I(5V)} = 5\text{ V}$ ,  $V_{I(12)} = 12\text{ V}$  (not applicable for TPS2223A) all outputs unloaded (unless otherwise noted)

PARAMETER†	LOAD CONDITION	TEST CONDITIONS‡	MIN	TYP	MAX	UNIT
$t_r$ Output rise times (see Note 1)	$C_L(xVCC) = 0.1\text{ }\mu\text{F}$ , $C_L(xVPP) = 0.1\text{ }\mu\text{F}$ , $I_O(xVCC) = 0\text{ A}$ , $I_O(xVPP) = 0\text{ A}$	$V_O(xVCC) = 5\text{ V}$		0.9		ms
		$V_O(xVPP) = 12\text{ V}$		0.26		
	$C_L(xVCC) = 150\text{ }\mu\text{F}$ , $C_L(xVPP) = 10\text{ }\mu\text{F}$ , $I_O(xVCC) = 0.75\text{ A}$ , $I_O(xVPP) = 50\text{ mA}$	$V_O(xVCC) = 5\text{ V}$		1.1		
		$V_O(xVPP) = 12\text{ V}$		0.6		
$t_f$ Output fall times (see Note 1)	$C_L(xVCC) = 0.1\text{ }\mu\text{F}$ , $C_L(xVPP) = 0.1\text{ }\mu\text{F}$ , $I_O(xVCC) = 0\text{ A}$ , $I_O(xVPP) = 0\text{ A}$	$V_O(xVCC) = 5\text{ V}$ , Discharge switches ON		0.5		ms
		$V_O(xVPP) = 12\text{ V}$ , Discharge switches ON		0.2		
	$C_L(xVCC) = 150\text{ }\mu\text{F}$ , $C_L(xVPP) = 10\text{ }\mu\text{F}$ , $I_O(xVCC) = 0.75\text{ A}$ , $I_O(xVPP) = 50\text{ mA}$	$V_O(xVCC) = 5\text{ V}$		2.35		
		$V_O(xVPP) = 12\text{ V}$		3.9		
$t_{pd}$ Propagation delay times (see Note 1)	$C_L(xVCC) = 0.1\text{ }\mu\text{F}$ , $C_L(xVPP) = 0.1\text{ }\mu\text{F}$ , $I_O(xVCC) = 0\text{ A}$ , $I_O(xVPP) = 0\text{ A}$	Latch $\uparrow$ to xVPP (12 V)§	$t_{pdon}$	2		ms
			$t_{pdoff}$	0.62		
		Latch $\uparrow$ to xVPP (5 V)	$t_{pdon}$	0.77		
			$t_{pdoff}$	0.51		
		Latch $\uparrow$ to xVPP (3.3 V)	$t_{pdon}$	0.75		
			$t_{pdoff}$	0.52		
		Latch $\uparrow$ to xVCC (5 V)	$t_{pdon}$	0.3		
			$t_{pdoff}$	2.5		
	$C_L(xVCC) = 150\text{ }\mu\text{F}$ , $C_L(xVPP) = 10\text{ }\mu\text{F}$ , $I_O(xVCC) = 0.75\text{ A}$ , $I_O(xVPP) = 50\text{ mA}$	Latch $\uparrow$ to xVCC (3.3V)	$t_{pdon}$	0.3		ms
			$t_{pdoff}$	2.8		
		Latch $\uparrow$ to xVPP (12 V)§	$t_{pdon}$	2.2		
			$t_{pdoff}$	0.8		
		Latch $\uparrow$ to xVPP (5 V)	$t_{pdon}$	0.8		
			$t_{pdoff}$	0.6		
		Latch $\uparrow$ to xVPP (3.3 V)	$t_{pdon}$	0.8		
			$t_{pdoff}$	0.6		
		Latch $\uparrow$ to xVCC (5 V)	$t_{pdon}$	0.6		
			$t_{pdoff}$	2.5		
		Latch $\uparrow$ to xVCC (3.3V)	$t_{pdon}$	0.5		
			$t_{pdoff}$	2.6		

† Refer to Parameter Measurement Information in Figure 1.

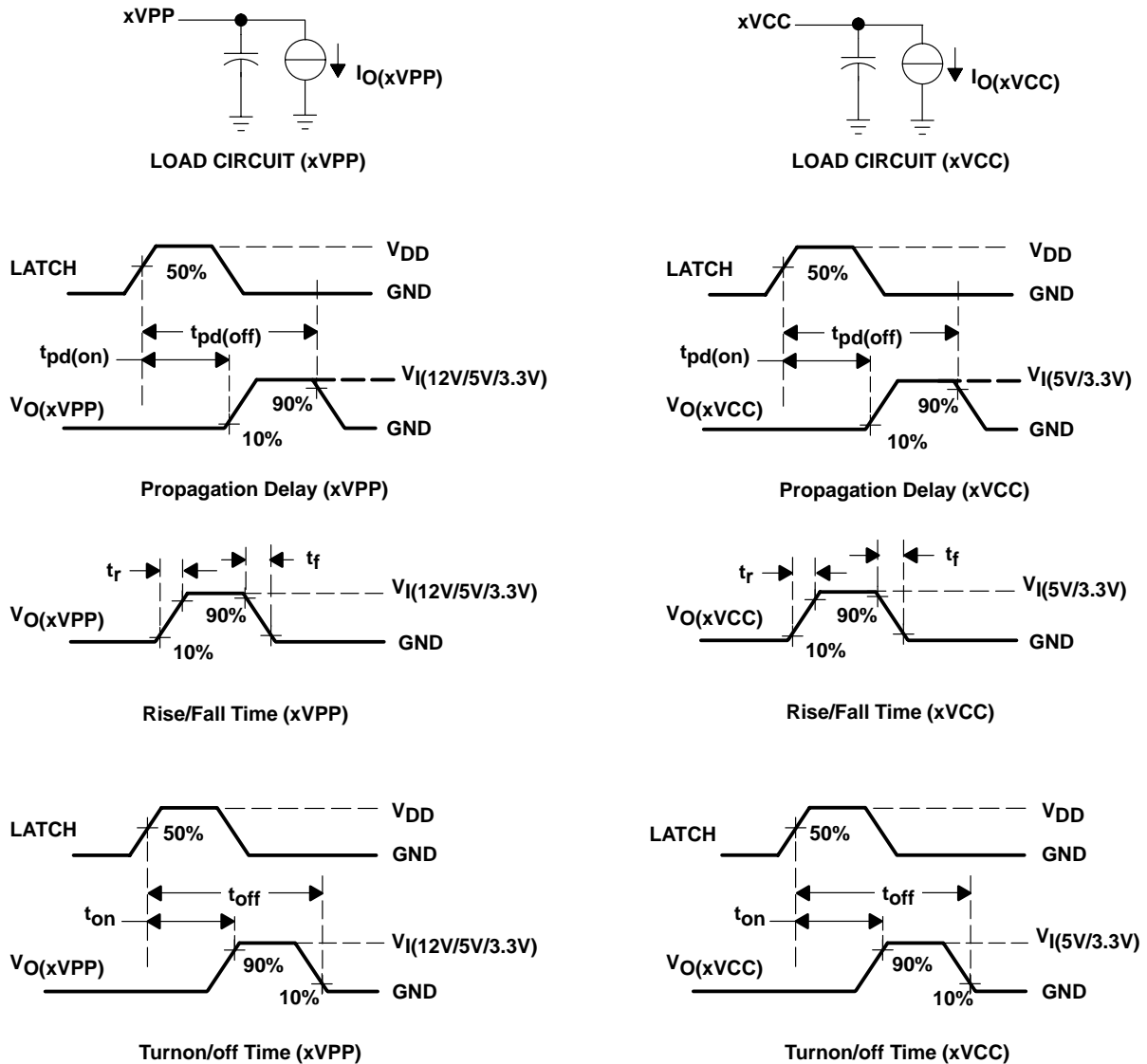
‡ No card inserted, assumes a 0.1- $\mu\text{F}$  output capacitor (see Figure 1).

§ Not applicable for TPS2223A

NOTE 1: Specified by design; not tested in production.



## PARAMETER MEASUREMENT INFORMATION



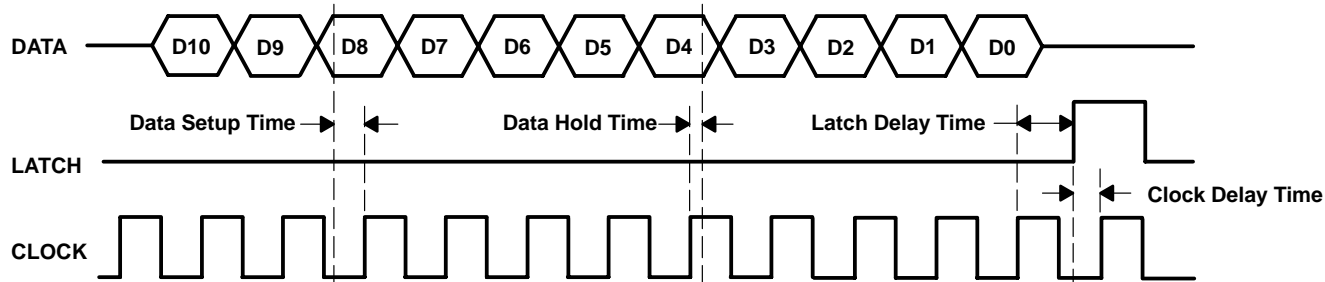
## VOLTAGE WAVEFORMS

Figure 1. Test Circuits and Voltage Waveforms

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## PARAMETER MEASUREMENT INFORMATION



NOTE: Data is clocked in on the positive edge of the clock. The positive edge of the latch signal should occur before the next positive edge of the clock. For definition of D0 to D10, see the control logic table.

Figure 2. Serial-Interface Timing for TPS2226A

## Table of Graphs

		FIGURE
Short-circuit response, short applied to powered-on 5-V xVCC-switch output	vs Time	3
Short-circuit response, short applied to powered-on 12-V xVPP-switch output	vs Time	4
$\overline{\text{OC}}$ response with ramped overcurrent-limit load on 5-V xVCC-switch output	vs Time	5
$\overline{\text{OC}}$ response with ramped overcurrent-limit load on 12-V xVPP-switch output	vs Time	6
xVCC Turnon propagation delay time ( $C_L = 150 \mu\text{F}$ )	vs Junction temperature	7
xVCC Turnoff propagation delay time ( $C_L = 150 \mu\text{F}$ )	vs Junction temperature	8
xVPP Turnon propagation delay time ( $C_L = 10 \mu\text{F}$ )	vs Junction temperature	9
xVPP Turnoff propagation delay time ( $C_L = 10 \mu\text{F}$ )	vs Junction temperature	10
xVCC Turnon propagation delay time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	11
xVCC Turnoff propagation delay time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	12
xVPP Turnon propagation delay time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	13
xVPP Turnoff propagation delay time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	14
xVCC Rise time ( $C_L = 150 \mu\text{F}$ )	vs Junction temperature	15
xVCC Fall time ( $C_L = 150 \mu\text{F}$ )	vs Junction temperature	16
xVPP Rise time ( $C_L = 10 \mu\text{F}$ )	vs Junction temperature	17
xVPP Fall time ( $C_L = 10 \mu\text{F}$ )	vs Junction temperature	18
xVCC Rise time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	19
xVCC Fall time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	20
xVPP Rise time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	21
xVPP Fall time ( $T_J = 25^\circ\text{C}$ )	vs Load capacitance	22

# PARAMETER MEASUREMENT INFORMATION

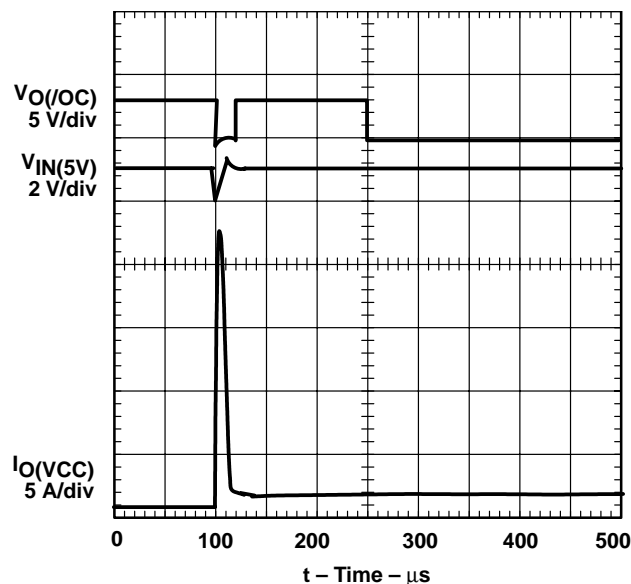


Figure 3. Short-Circuit Response, Short Applied to Powered-on 5-V xVCC-Switch Output

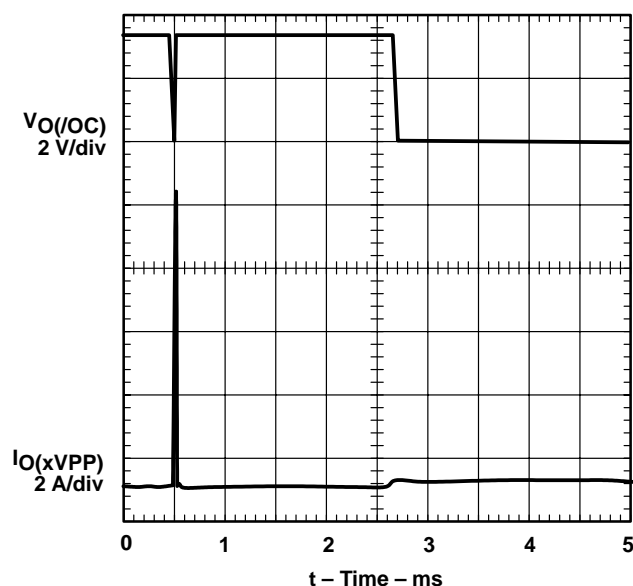


Figure 4. Short-Circuit Response, Short Applied to Powered-on 12-V xVPP-Switch Output

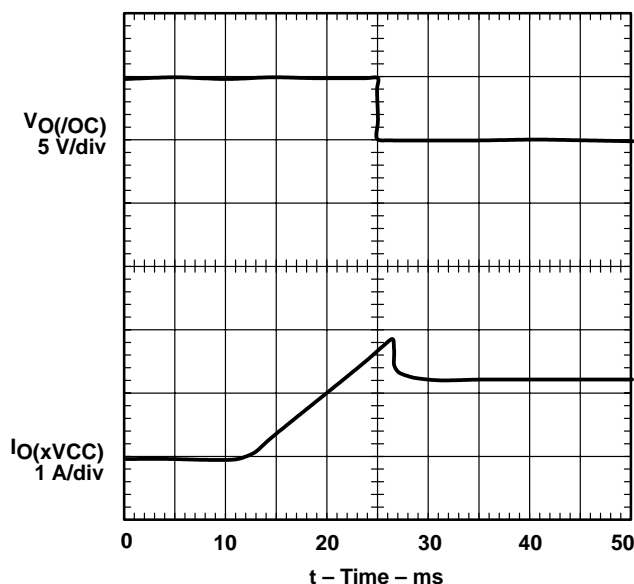


Figure 5.  $\overline{OC}$  Response With Ramped Overcurrent-Limit Load on 5-V xVCC-Switch Output

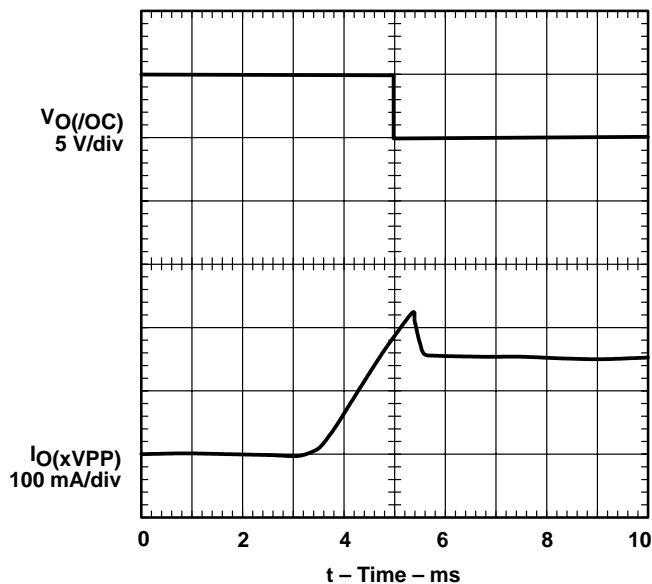


Figure 6.  $\overline{OC}$  Response With Ramped Overcurrent-Limit Load on 12-V xVPP-Switch Output

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## PARAMETER MEASUREMENT INFORMATION

TURNON PROPAGATION DELAY TIME, xVCC  
vs  
JUNCTION TEMPERATURE

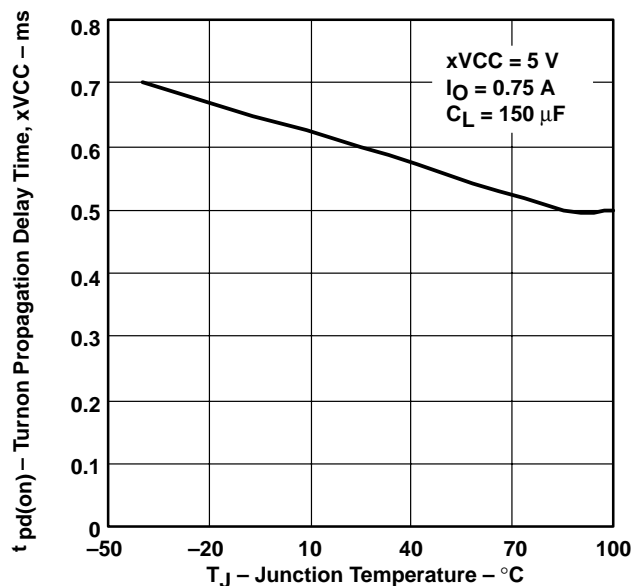


Figure 7

TURNOFF PROPAGATION DELAY TIME, xVCC  
vs  
JUNCTION TEMPERATURE

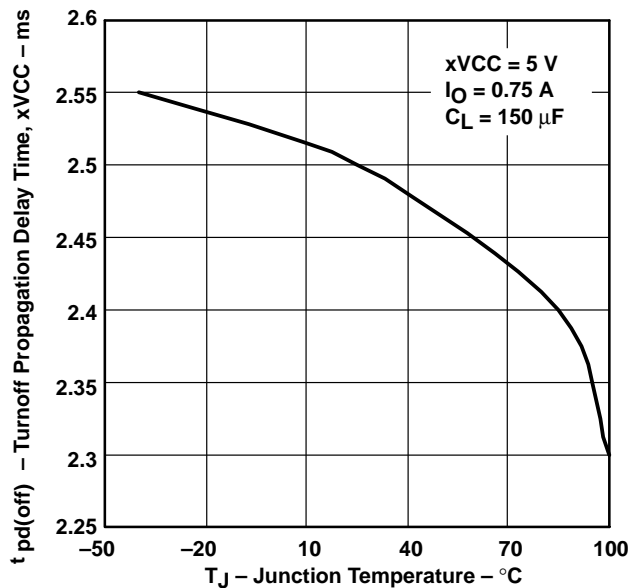


Figure 8

TURNON PROPAGATION DELAY TIME, xVPP  
vs  
JUNCTION TEMPERATURE

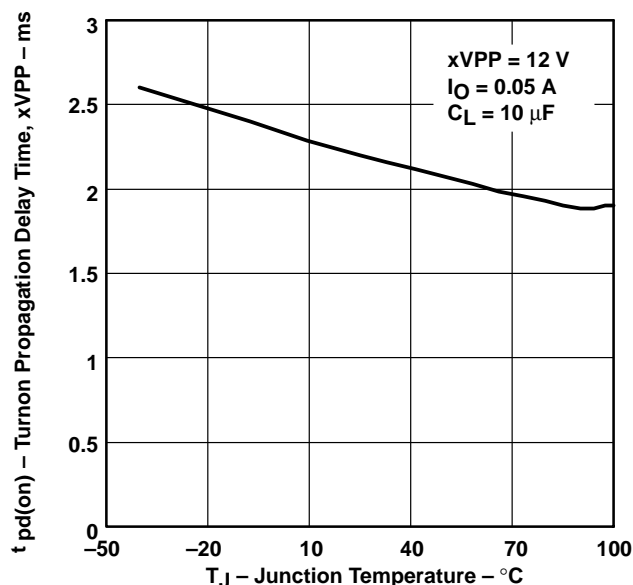


Figure 9

TURNOFF PROPAGATION DELAY TIME, xVPP  
vs  
JUNCTION TEMPERATURE

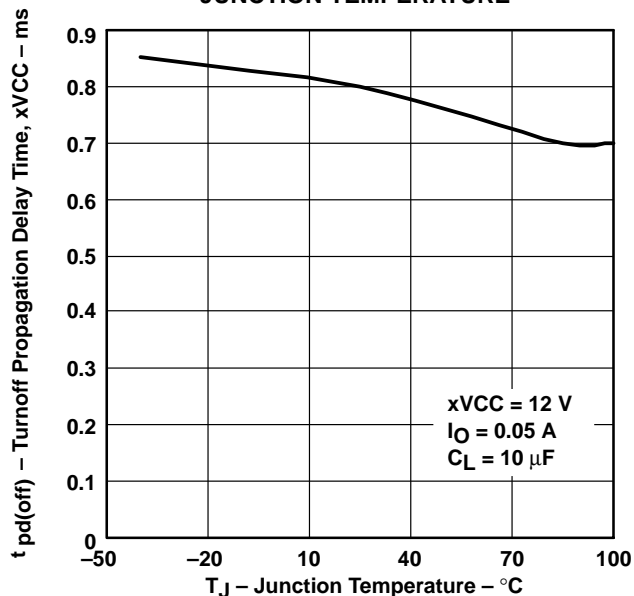


Figure 10

## PARAMETER MEASUREMENT INFORMATION

TURNON PROPAGATION DELAY TIME, xVCC  
 vs  
 LOAD CAPACITANCE

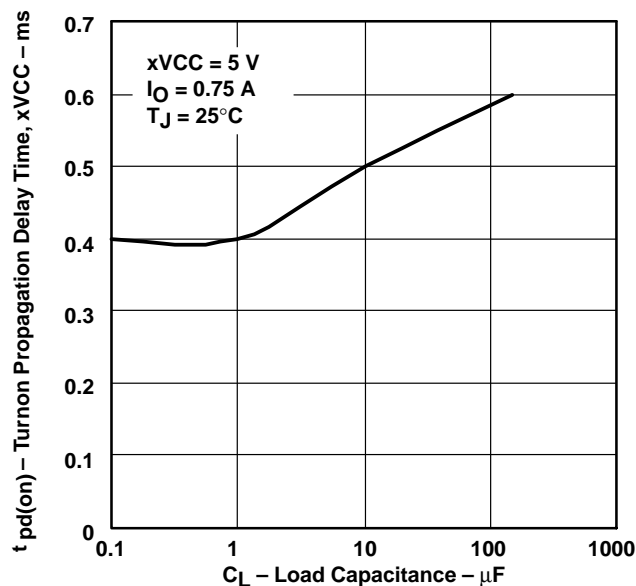


Figure 11

TURNOFF PROPAGATION DELAY TIME, xVCC  
 vs  
 LOAD CAPACITANCE

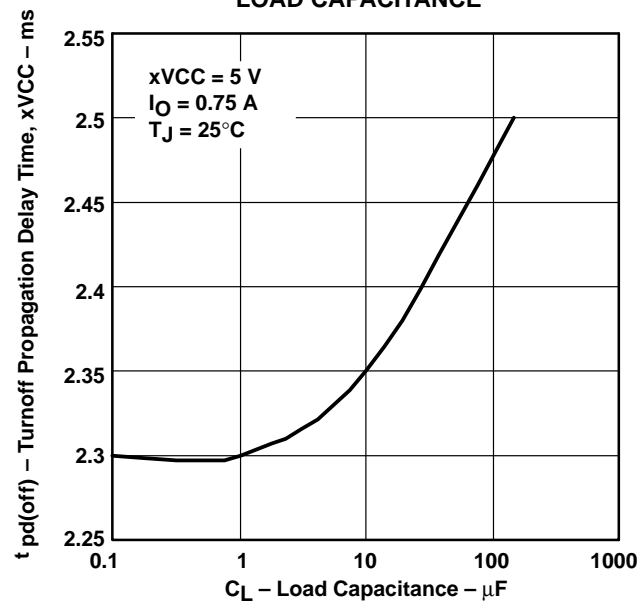


Figure 12

TURNON PROPAGATION DELAY TIME, xVPP  
 vs  
 LOAD CAPACITANCE

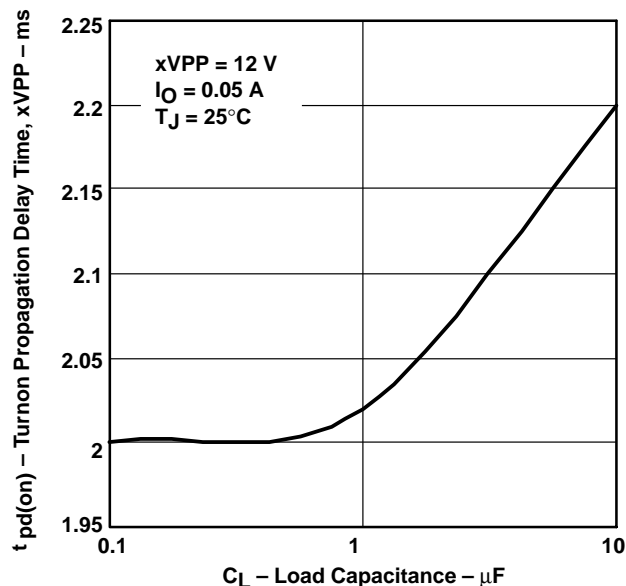


Figure 13

TURNOFF PROPAGATION DELAY TIME, xVPP  
 vs  
 LOAD CAPACITANCE

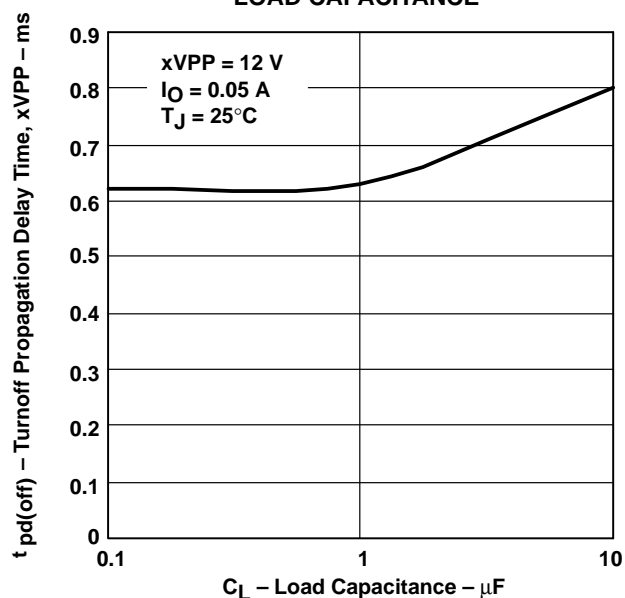
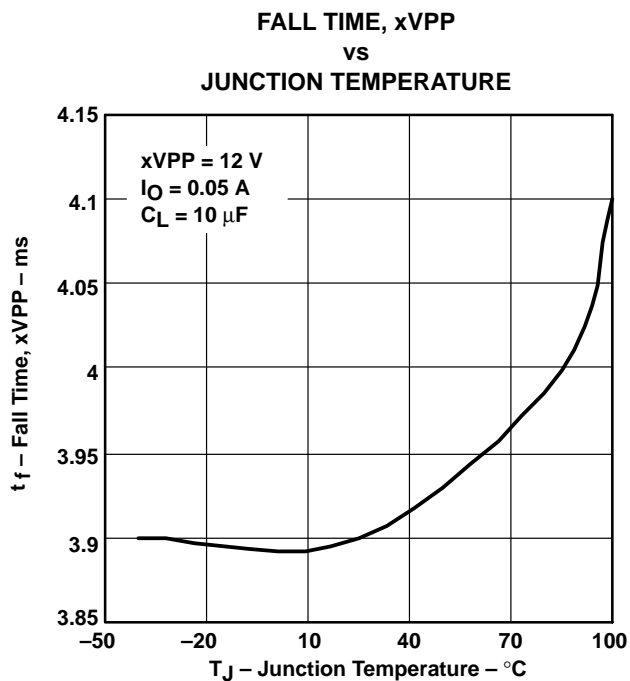
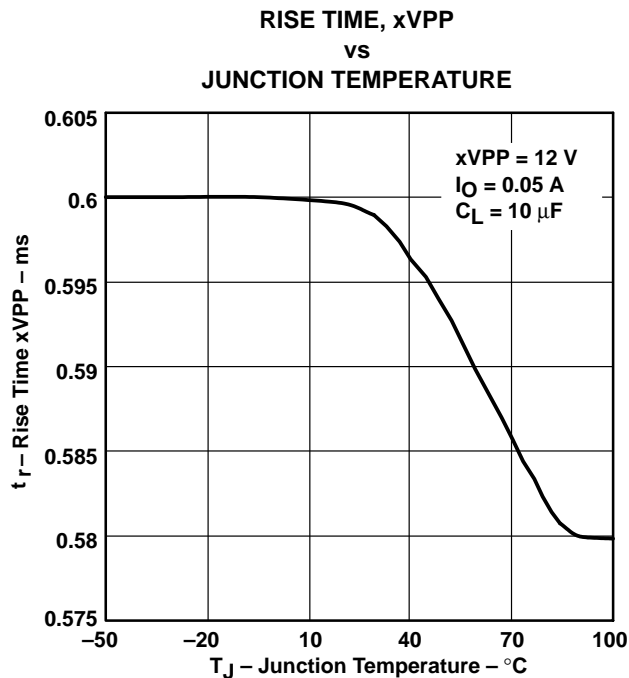
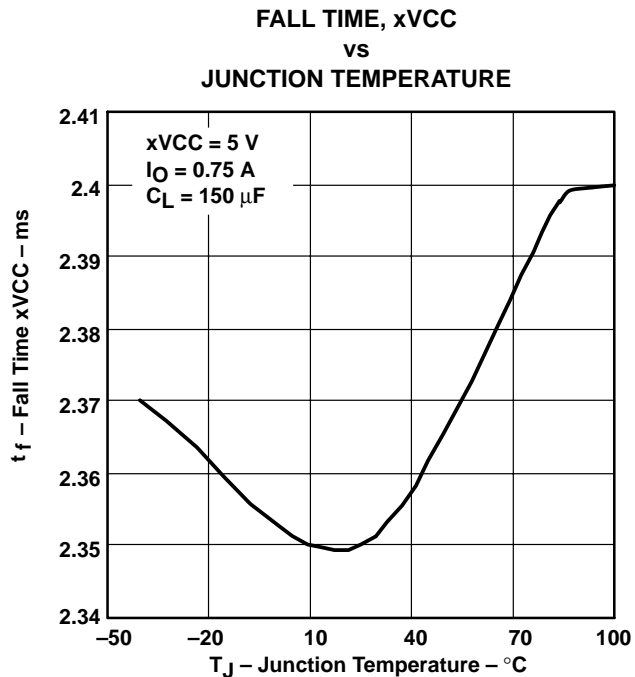
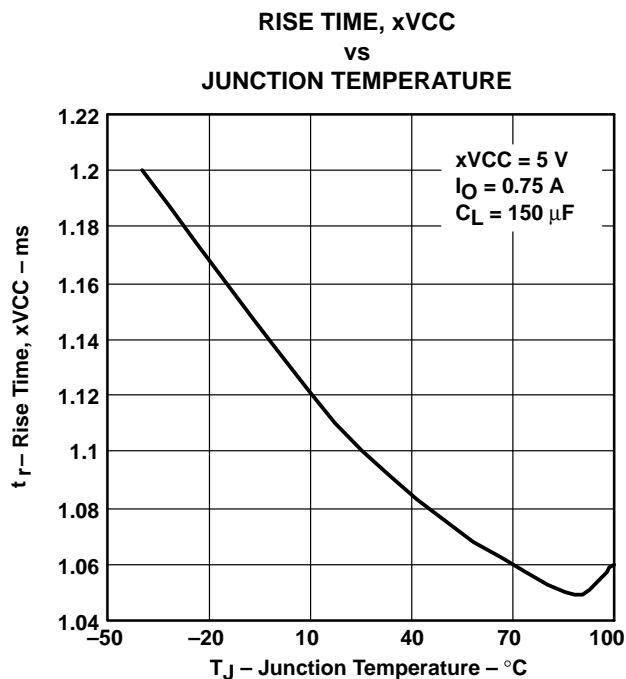


Figure 14

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## PARAMETER MEASUREMENT INFORMATION



## PARAMETER MEASUREMENT INFORMATION

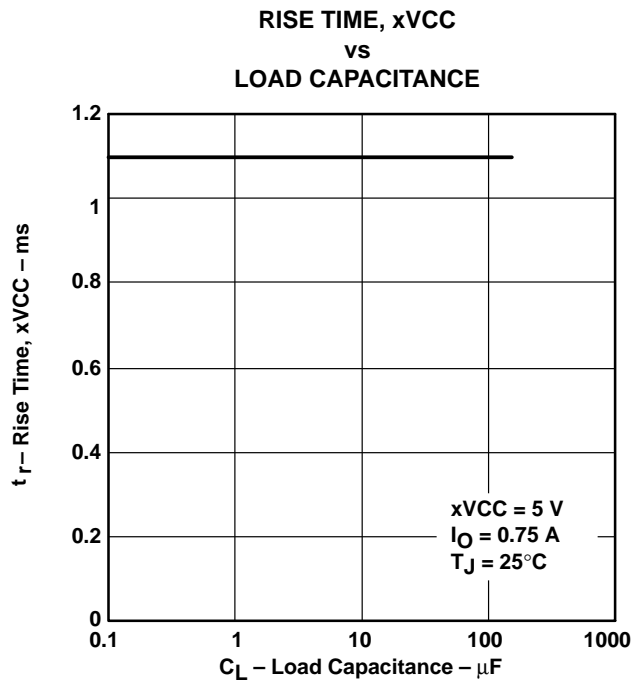


Figure 19

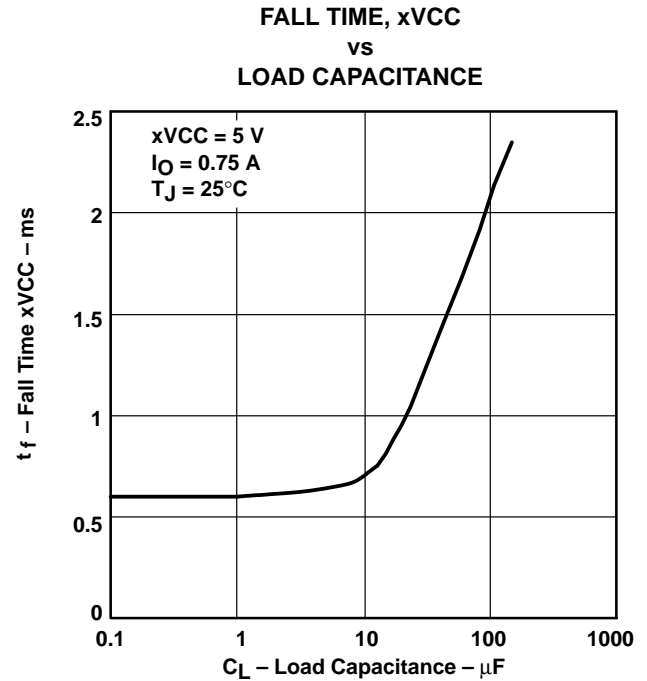


Figure 20

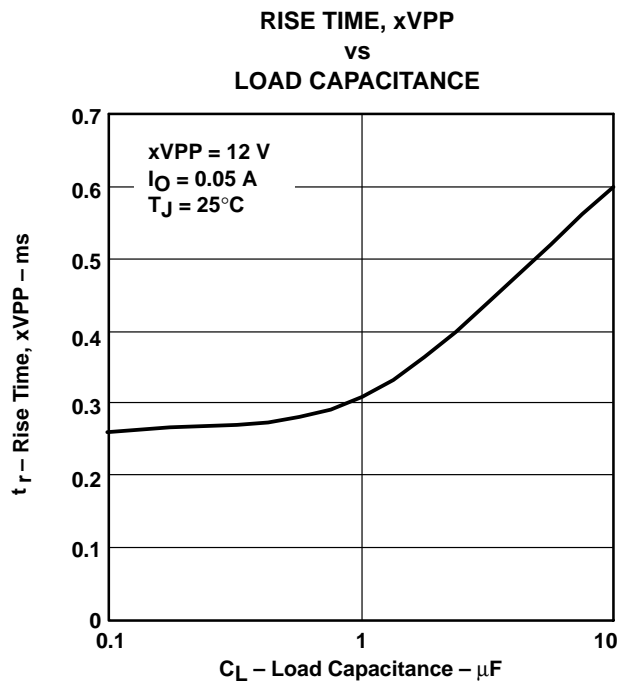


Figure 21

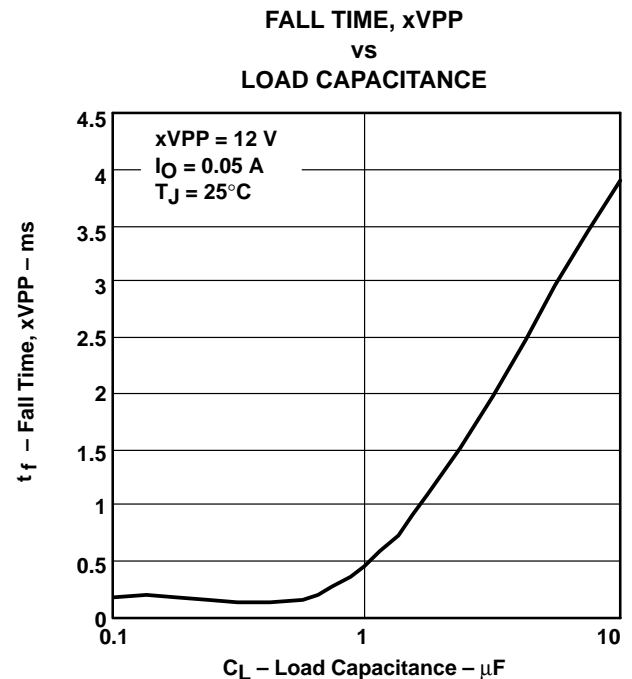


Figure 22

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## TYPICAL CHARACTERISTICS

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INPUT CURRENT, xVCC = 3.3 V  
vs  
JUNCTION TEMPERATURE

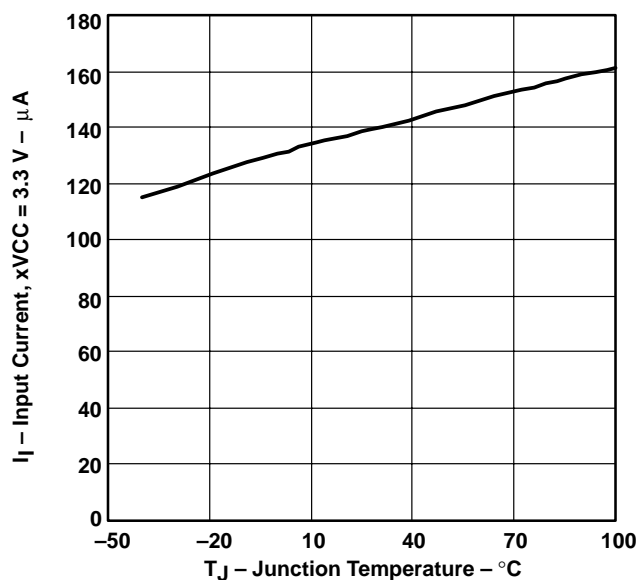


Figure 23

INPUT CURRENT, xVCC = 5 V  
vs  
JUNCTION TEMPERATURE

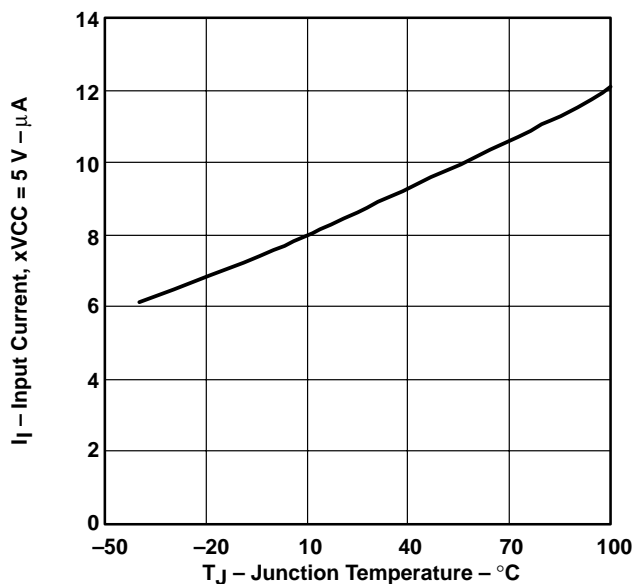


Figure 24



## TYPICAL CHARACTERISTICS

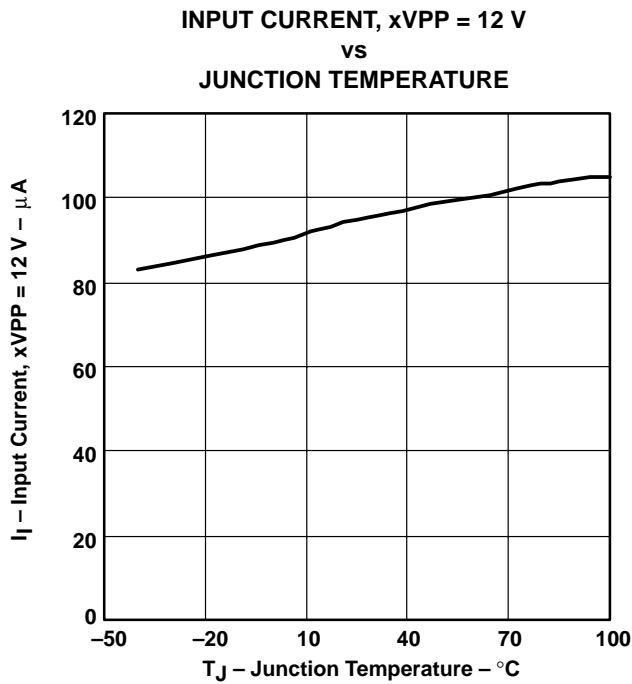


Figure 25

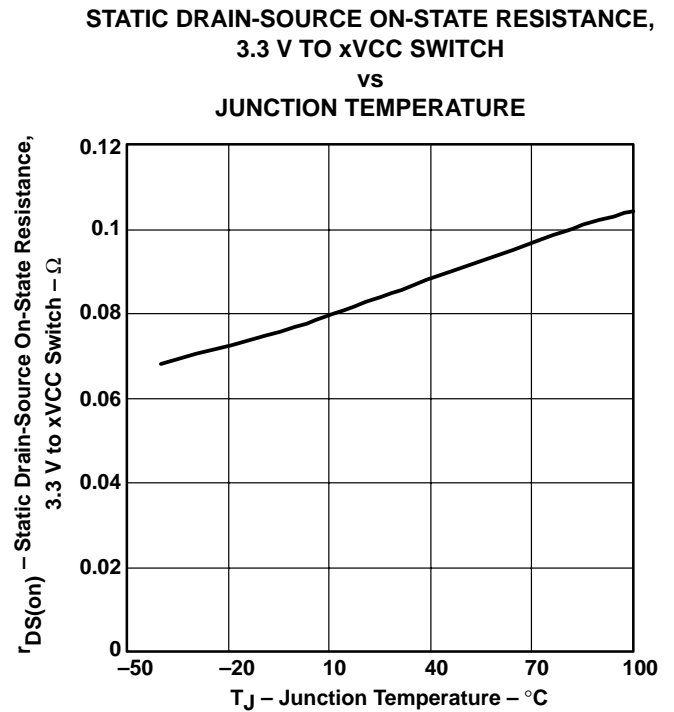


Figure 26

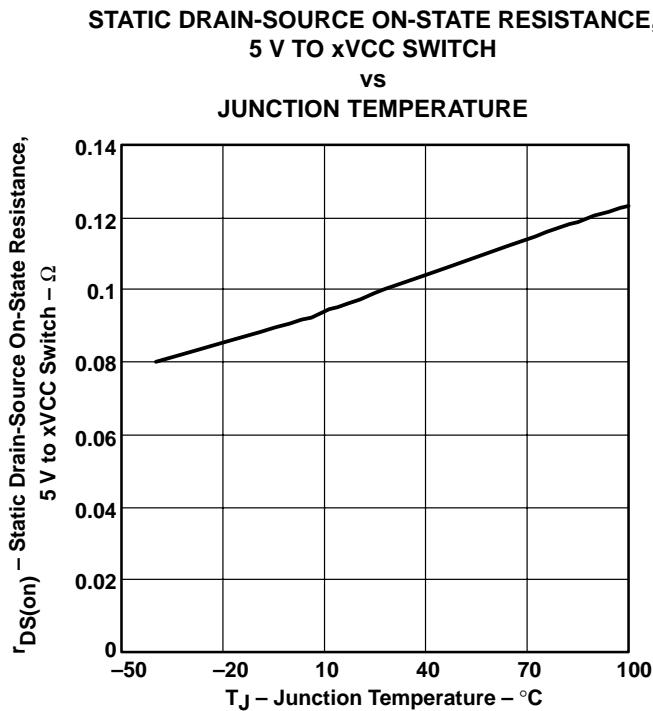


Figure 27

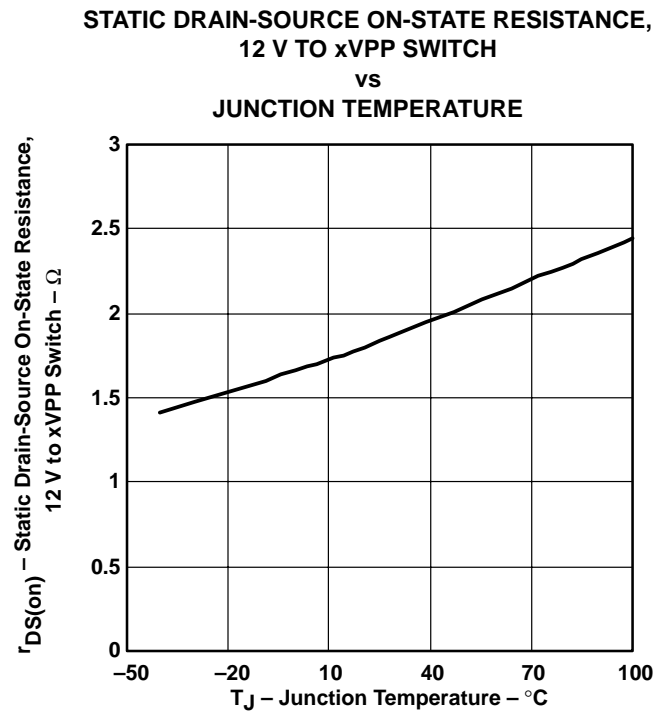


Figure 28

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## TYPICAL CHARACTERISTICS

**xVCC SWITCH VOLTAGE DROP, 3.3-V INPUT**  
vs  
**LOAD CURRENT**

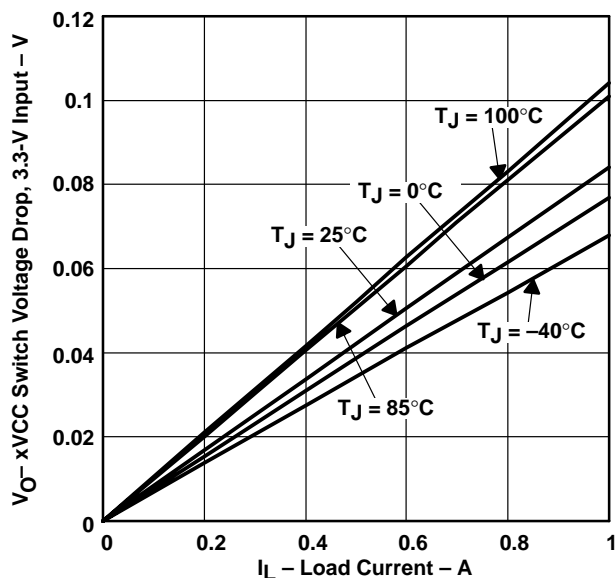


Figure 29

**xVCC SWITCH VOLTAGE DROP, 5-V INPUT**  
vs  
**LOAD CURRENT**

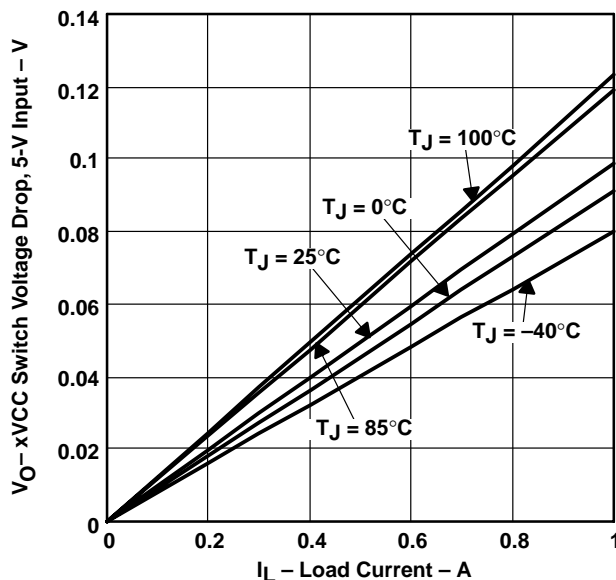


Figure 30

**xVPP SWITCH VOLTAGE DROP, 12-V INPUT**  
vs  
**LOAD CURRENT**

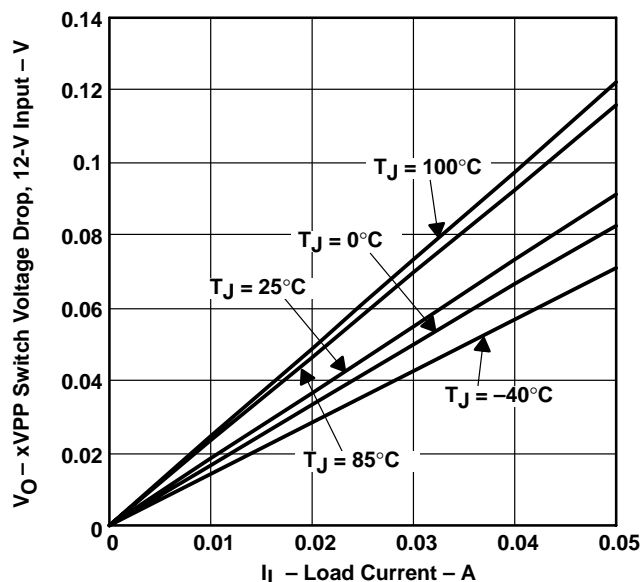


Figure 31

**SHORT-CIRCUIT CURRENT LIMIT, 3.3 V TO xVCC**  
vs  
**JUNCTION TEMPERATURE**

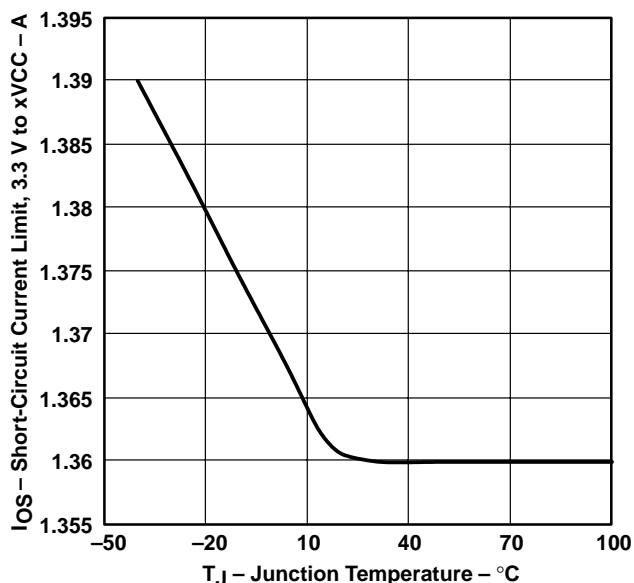


Figure 32

## TYPICAL CHARACTERISTICS

SHORT-CIRCUIT CURRENT LIMIT, 5 V TO xVCC  
vs  
JUNCTION TEMPERATURE

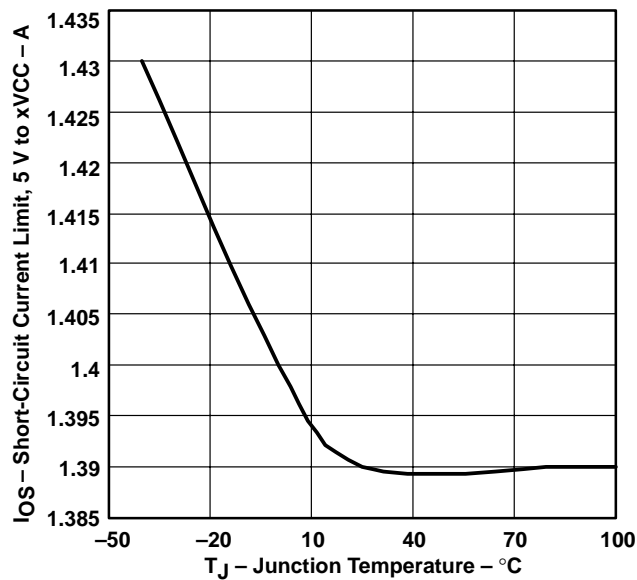


Figure 33

SHORT-CIRCUIT CURRENT LIMIT, 12 V TO xVPP  
vs  
JUNCTION TEMPERATURE

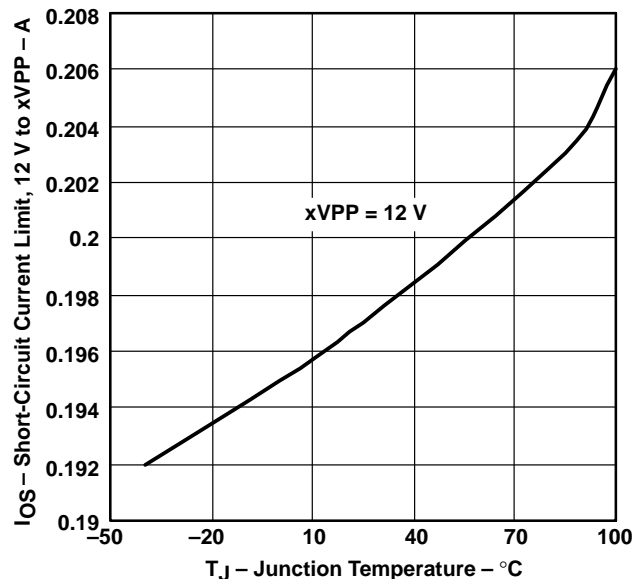


Figure 34

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## APPLICATION INFORMATION

### overview

PC Cards were initially introduced as a means to add flash memory to portable computers. The idea of add-in cards quickly took hold, and modems, wireless LANs, global positioning satellite system (GPS), multimedia, and hard-disk versions were soon available. As the number of PC Card applications grew, the engineering community quickly recognized the need for a standard to ensure compatibility across platforms. To this end, the PCMCIA (Personal Computer Memory Card International Association) was established, comprising members from leading computer, software, PC Card, and semiconductor manufacturers. One key goal was to realize the *plug-and-play* concept, so that cards and hosts from different vendors would be transparently compatible.

### PC Card power specification

System compatibility also means power compatibility. The most current set of specifications (PC Card Standard) set forth by the PCMCIA committee states that power is to be transferred between the host and the card through eight of the 68 terminals of the PC Card connector. This power interface consists of two  $V_{CC}$ , two  $V_{pp}$ , and four ground terminals. Multiple  $V_{CC}$  and ground terminals minimize connector-terminal and line resistance. The two  $V_{pp}$  terminals were originally specified as separate signals, but are normally tied together in the host to form a single node to minimize voltage losses. Card primary power is supplied through the  $V_{CC}$  terminals; flash-memory programming and erase voltage is supplied through the  $V_{pp}$  terminals. Cardbus cards of today typically do not use 12 V, which is now more of an optional requirement in the host.

### designing for voltage regulation

The current PCMCIA specification for output voltage regulation,  $V_{O(reg)}$ , of the 5-V output is 5% (250 mV). In a typical PC power-system design, the power supply has an output-voltage regulation,  $V_{PS(reg)}$ , of 2% (100 mV). Also, a voltage drop from the power supply to the PC Card results from resistive losses,  $V_{PCB}$ , in the PCB traces and the PCMCIA connector. A typical design would limit the total of these resistive losses to less than 1% (50 mV) of the output voltage. Therefore, the allowable voltage drop,  $V_{DS}$ , for the TPS2220A, TPS2223A, TPS2224A, and TPS2226A would be the PCMCIA voltage regulation less the power supply regulation and less the PCB and connector resistive drops:

$$V_{DS} = V_{O(reg)} - V_{PS(reg)} - V_{PCB}$$

Typically, this would leave 100 mV for the allowable voltage drop across the 5-V switch. The specification for output voltage regulation of the 3.3-V output is 300 mV; therefore, using the same equation by deducting the voltage drop percentages (2%) for power-supply regulation and PCB resistive loss (1%), the allowable voltage drop for the 3.3-V switch is 200 mV. The voltage drop is the output current multiplied by the switch resistance of the device. Therefore, the maximum output current,  $I_{Omax}$ , that can be delivered to the PC Card in regulation is the allowable voltage drop across the IC, divided by the output-switch resistance.

$$I_{Omax} = \frac{V_{DS}}{r_{DS(on)}}$$

The xVCC outputs have been designed to deliver the peak and average currents defined by the PC Card specification within regulation over the operating temperature range. The xVPP outputs of the device have been designed to deliver 100 mA continuously.

## **APPLICATION INFORMATION**

### **overcurrent and overtemperature protection**

PC Cards are inherently subject to damage that can result from mishandling. Host systems require protection against short-circuited cards that could lead to power-supply or PCB trace damage. Even extremely robust systems could undergo rapid battery discharge into a damaged PC Card, resulting in the rather sudden and unacceptable loss of system power. The reliability of fused systems is poor, in comparison, as blown fuses require troubleshooting and repair, usually by the manufacturer.

The TPS2220A, TPS2223A, TPS2224A, and TPS2226A take a two-pronged approach to overcurrent protection, which is designed to activate if an output is shorted or when an overcurrent condition is present when switches are powered up. First, instead of fuses, sense FETs monitor each of the xVCC and xVPP power outputs. Unlike sense resistors or polyfuses, these FETs do not add to the series resistance of the switch; therefore voltage and power losses are reduced. Overcurrent sensing is applied to each output separately. Excessive current generates an error signal that limits the output current of only the affected output, preventing damage to the host. Each xVCC output overcurrent limits from 1 A to 2.2 A, typically around 1.6 A; the xVPP outputs limit from 100 mA to 250 mA, typically around 200 mA.

Second, when an overcurrent condition is detected, the TPS2220A, TPS2223A, TPS2224A, and TPS2226A assert an active low  $\overline{OC}$  signal that can be monitored by the microprocessor or controller to initiate diagnostics and/or send the user a warning message. If an overcurrent condition persists, causing the IC to exceed its maximum junction temperature, thermal-protection circuitry activates, shutting down all power outputs until the device cools to within a safe operating region, which is ensured by a thermal shutdown hysteresis. Thermal limiting prevents destruction of the IC from overheating beyond the package power-dissipation ratings.

During power up, the devices control the rise times of the xVCC and xVPP outputs and limit the inrush current into a large load capacitance, faulty card, or connector.

### **12-V supply not required**

Some PC Card switches use the externally supplied 12 V to power gate drive and other chip functions, which requires that power be present at all times. The TPS2220A, TPS2224A and TPS2226A offer considerable power savings by using an internal charge pump to generate the required higher gate drive voltages from the 3.3-V input. Therefore, the external 12-V supply can be disabled except when needed by the PC Card in the slot, thereby extending battery lifetime. A special feature in the 12-V circuitry actually helps to reduce the supply current demanded from the 3.3-V input. When 12 V is supplied and requested at the VPP output, a voltage selection circuit will draw the charge-pump drive current for the 12-V FETs from the 12-V input. This selection is automatic and effectively reduces demand fluctuations on the normal 3.3-V VCC rail. For proper operation of this feature, a minimum 3.3-V input capacitance of 4.7  $\mu$ F is recommended, and a minimum 12-V input ramp-up rate of 12 V/50 ms (240 V/s) is required. Additional power savings are realized during a software shutdown in which quiescent current drops to a maximum of 1  $\mu$ A.

### **voltage-transitioning requirement**

PC Cards, like portables, are migrating from 5 V to 3.3 V to minimize power consumption, optimize board space, and increase logic speeds. The TPS2220A, TPS2223A, TPS2224A, and TPS2226A meet all combinations of power delivery as currently defined in the PCMCIA standard. The latest protocol accommodates mixed 3.3-V/5-V systems by first powering the card with 5 V, then polling it to determine its 3.3-V compatibility. The PCMCIA specification requires that the capacitors on 3.3-V-compatible cards be discharged to below 0.8 V before applying 3.3-V power. This action ensures that sensitive 3.3-V circuitry is not subjected to any residual 5-V charge and functions as a power reset. PC Card specification requires that  $V_{CC}$  be discharged within 100 ms. PC Card resistance cannot be relied on to provide a discharge path for voltages stored on PC Card capacitance because of possible high-impedance isolation by power-management schemes. The devices include discharge transistors on all xVCC and xVPP outputs to meet the specification requirement.

# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## APPLICATION INFORMATION

### shutdown mode

In the shutdown mode, which can be controlled by  $\overline{\text{SHDN}}$  or bit D8 of the input serial DATA word, each of the xVCC and xVPP outputs is forced to a high-impedance state. In this mode, the chip quiescent current is reduced to 1  $\mu\text{A}$  or less to conserve battery power.

### power-supply considerations

These switches have multiple pins for each 3.3-V (except for TPS2220A) and 5-V power input and for the switched xVCC outputs. Any individual pin can conduct the rated input or output current. Unless all pins are connected in parallel, the series resistance is higher than that specified, resulting in increased voltage drops and power loss. It is recommended that all input and output power pins be paralleled for optimum operation.

To increase the noise immunity of the TPS2220A, TPS2223A, TPS2224A, and TPS2226A, the power-supply inputs should be bypassed with at least a 4.7- $\mu\text{F}$  electrolytic or tantalum capacitor paralleled by a 0.047- $\mu\text{F}$  to 0.1- $\mu\text{F}$  ceramic capacitor. It is strongly recommended that the switched outputs be bypassed with a 0.1- $\mu\text{F}$  (or larger) ceramic capacitor; doing so improves the immunity of the IC to electrostatic discharge (ESD). Care should be taken to minimize the inductance of PCB traces between the devices and the load. High switching currents can produce large negative voltage transients, which forward biases substrate diodes, resulting in unpredictable performance. Similarly, no pin should be taken below  $-0.3\text{ V}$ .

### $\overline{\text{RESET}}$ input

To ensure that cards are in a known state after power brownouts or system initialization, the PC Cards should be reset at the same time as the host by applying low-impedance paths from xVCC and xVPP terminals to ground. A low-impedance output state allows discharging of residual voltage remaining on PC Card filter capacitance, permitting the system (host and PC Cards) to be powered up concurrently. The active low  $\overline{\text{RESET}}$  input closes internal ground switches S1, S4, S7, and S11 with all other switches left open. The TPS2220A, TPS2223A, TPS2224A, and TPS2226A remain in the low-impedance output state until the signal is deasserted and further data is clocked in and latched. The input serial data cannot be latched during reset mode.  $\overline{\text{RESET}}$  is provided for direct compatibility with systems that use an active-low reset voltage supervisor. The  $\overline{\text{RESET}}$  pin has an internal 150-k $\Omega$  pullup resistor.

### calculating junction temperature

The switch resistance,  $r_{\text{DS(on)}}$ , is dependent on the junction temperature,  $T_J$ , of the die. The junction temperature is dependent on both  $r_{\text{DS(on)}}$  and the current through the switch. To calculate  $T_J$ , first find  $r_{\text{DS(on)}}$  from Figures 26 through 28, using an initial temperature estimate about 30°C above ambient. Then calculate the power dissipation for each switch, using the formula:

$$P_D = r_{\text{DS(on)}} \times I^2$$

Next, sum the power dissipation of all switches and calculate the junction temperature:

$$T_J = \left( \sum P_D \times R_{\theta\text{JA}} \right) + T_A$$

where:

$R_{\theta\text{JA}}$  is the inverse of the derating factor given in the dissipation rating table.

Compare the calculated junction temperature with the initial temperature estimate. If the temperatures are not within a few degrees of each other, recalculate using the calculated temperature as the initial estimate.

## APPLICATION INFORMATION

### logic inputs and outputs

The serial interface consists of the DATA, CLOCK, and LATCH leads. The data is clocked in on the positive edge of the clock (see Figure 2). The 11-bit (D0–D10) serial data word is loaded during the positive edge of the latch signal. The positive edge of the latch signal should occur before the next positive edge of the clock occurs.

The serial interface of the device is compatible with serial-interface PCMCIA controllers.

An overcurrent output ( $\overline{OC}$ ) is provided to indicate an overcurrent or overtemperature condition in any of the xVCC and xVPP outputs as previously discussed.

### TPS2220A, TPS2223A, TPS2224A, and TPS2226A control logic

#### xVPP

D8 ( $\overline{SHDN}$ )	AVPP CONTROL SIGNALS			OUTPUT V_AVPP	BVPP CONTROL SIGNALS				OUTPUT V_BVPP
	D0	D1	D9		D8 ( $\overline{SHDN}$ )	D4	D5	D10	
1	0	0	X	0 V	1	0	0	X	0 V
1	0	1	0	3.3 V	1	0	1	0	3.3 V
1	0	1	1	5 V	1	0	1	1	5 V
1	1	0	X	12 V <sup>†</sup>	1	1	0	X	12 V <sup>†</sup>
1	1	1	X	Hi-Z	1	1	1	X	Hi-Z
0	X	X	X	Hi-Z	0	X	X	X	Hi-Z

<sup>†</sup> The output V\_xVPP is Hi-Z for TPS2223A.

#### xVCC

D8 ( $\overline{SHDN}$ )	AVCC CONTROL SIGNALS		OUTPUT V_AVCC	BVCC CONTROL SIGNALS			OUTPUT V_BVCC
	D3	D2		D8 ( $\overline{SHDN}$ )	D6	D7	
1	0	0	0 V	1	0	0	0 V
1	0	1	3.3 V	1	0	1	3.3 V
1	1	0	5 V	1	1	0	5 V
1	1	1	0 V	1	1	1	0 V
0	X	X	Hi-Z	0	X	X	Hi-Z

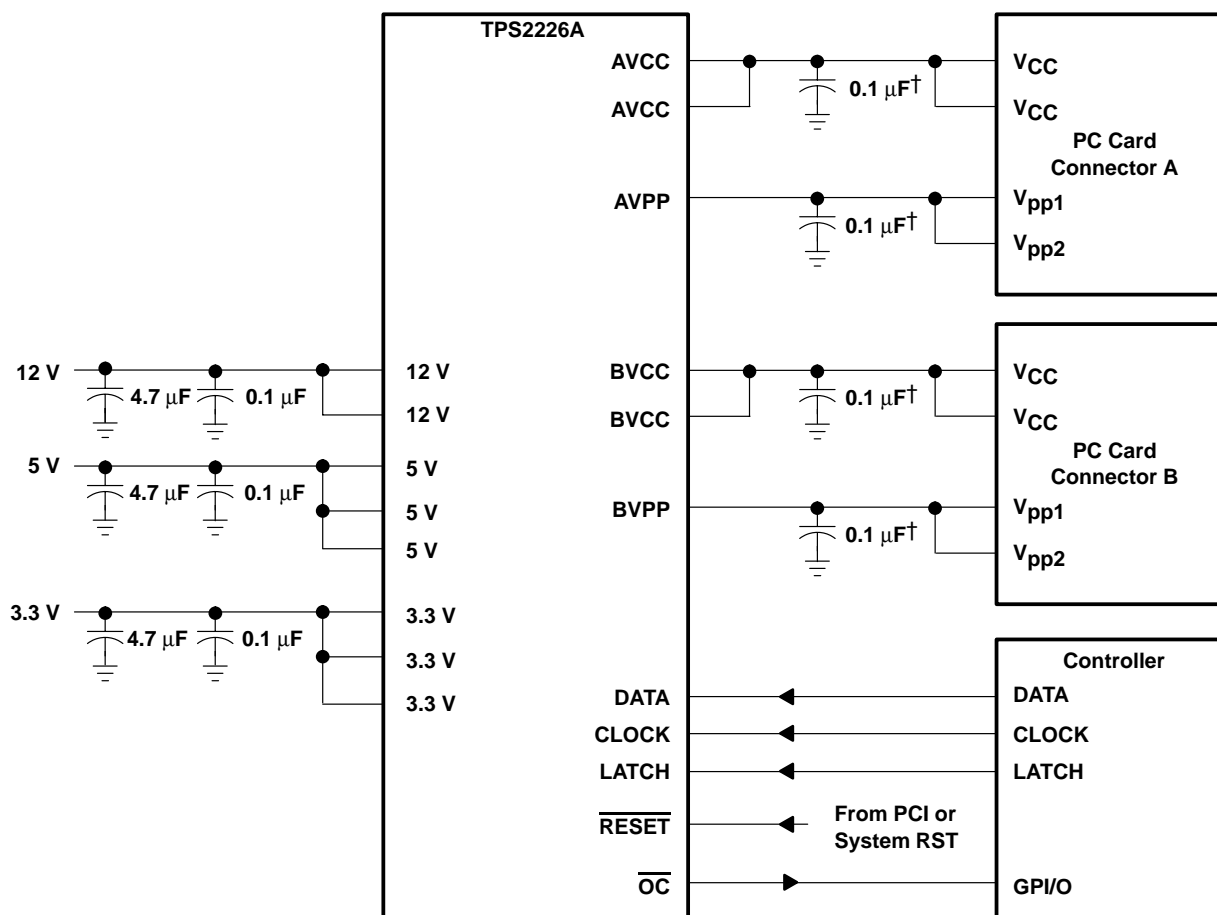
# TPS2220A, TPS2223A, TPS2224A, TPS2226A CARDBUS POWER-INTERFACE SWITCHES FOR SERIAL PCMCIA CONTROLLERS

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## APPLICATION INFORMATION

### ESD protections (see Figure 35)

All inputs and outputs of these devices incorporate ESD-protection circuitry designed to withstand a 2-kV human-body-model discharge as defined in MIL-STD-883C, Method 3015. The xVCC and xVPP outputs can be exposed to potentially higher discharges from the external environment through the PC Card connector. Bypassing the outputs with 0.1- $\mu$ F capacitors protects the devices from discharges up to 10 kV.



† Maximum recommended output capacitance for xVCC is 220  $\mu$ F including card capacitance, and for xVPP is 10  $\mu$ F, without  $\overline{\text{OC}}$  glitch when switches are powered on.

**Figure 35. Detailed Interconnections and Capacitor Recommendations**



## 12-V flash memory supply

The TPS6734 is a 170-kHz current-mode PWM (pulse-width modulation) controller with an n-channel MOSFET power switch. Gate drive for the switch is derived from the 12-V output after start-up to minimize the die area needed to realize the 0.7- $\Omega$  MOSFET and improve efficiency at input voltages below 5 V. Soft start is accomplished with the addition of one small capacitor. A 1.22-V reference, pin 2 of TPS6734, is brought out for external use. For additional information, see the TPS6734 data sheet (SLVS127).

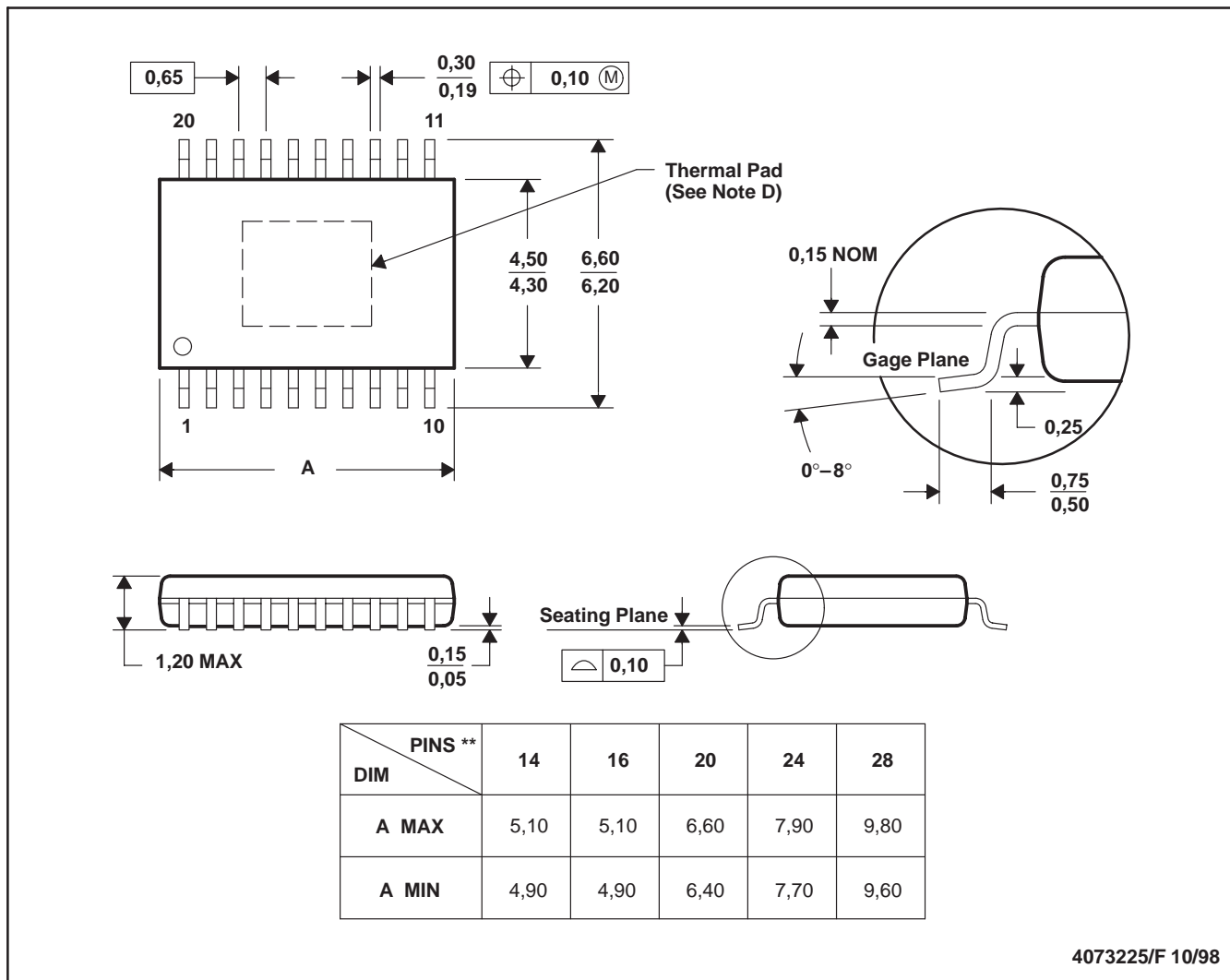


NOTE A: The enable terminal can be tied to a general-purpose I/O terminal on the PCMCIA controller or tied high.

**Figure 36. TPS2224A and TPS2226A with TPS6734 12-V, 120-mA Supply**

**PWP (R-PDSO-G\*\*)****PowerPAD™ PLASTIC SMALL-OUTLINE**

20 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusions.
  - The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.
  - Falls within JEDEC MO-153

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## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

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